

MiniSKiiP[®]0

3-phase bridge inverter

SKiiP 03 AC 126 V1

Preliminary Data

Features

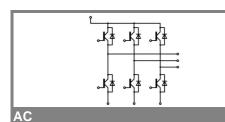
- Fast Trench IGBTs
- · Robust and soft freewheeling diodes in CAL technology
- Highly reliable spring contacts for electrical connections
- UL recognised file no. E63532

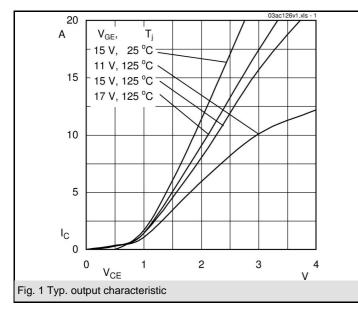
Remarks

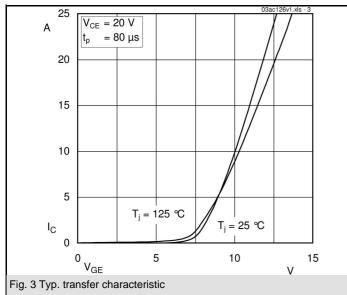
- V_{CEsat}, V_F = chip level value
 without T-Sensor

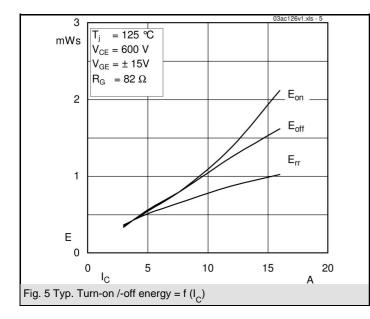
 T_{S} = 25 °C, unless otherwise specified **Absolute Maximum Ratings** Symbol |Conditions Values Units **IGBT - Inverter** 1200 V V_{CES} T_s = 25 (70) °C 16 (15) А I_{C} $t_p \le 1 \text{ ms}$ 16 А I_{CRM} V_{GES} ± 20 V T_i -40...+150 °C **Diode - Inverter** T_s = 25 (70) °C 14 (11) А I_{F} $t_p \le 1 \text{ ms}$ 16 А I_{FRM} °C -40...+150 T_{j} per power terminal (20 A / spring) 20 А I_{tRMS} -40...+125 °C $T_{op} \le T_{stg}$ T_{stg} V_{isol} AC, 1 min. 2500 V

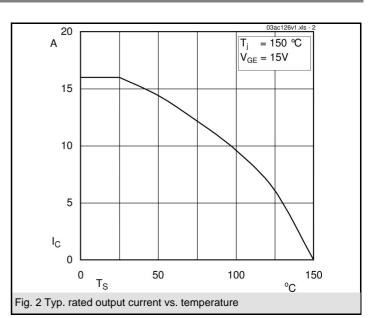
Characteristics		T _S = 25 °C	T_S = 25 °C, unless otherwise specified			
Symbol	Conditions	min.	typ.	max.	Units	
IGBT - Inverter						
V _{CEsat}	I _{Cnom} = 8 A, T _j = 25 (125) °C		1,7 (2)	2,1 (2,4)	V	
V _{GE(th)}	$V_{GE} = V_{CE}, I_{C} = 0,3 \text{ mA}$	5	5,8	6,5	V	
V _{CE(TO)}	T _j = 25 (125) °C		1 (0,9)	1,2 (1,1)	V	
r _T	T _j = 25 (125) °C		87 (138)	113 (162)	mΩ	
C _{ies}	V _{CE} = 25 V, V _{GE} = 0 V, f = 1 MHz		0,7		nF	
C _{oes}	V _{CE} = 25 V, V _{GE} = 0 V, f = 1 MHz		0,1		nF	
C _{res}	V _{CE} = 25 V, V _{GE} = 0 V, f = 1 MHz		0,1		nF	
R _{th(j-s)}	per IGBT		1,5		K/W	
t _{d(on)}	under following conditions		40		ns	
t _r	V_{CC} = 600 V, V_{GE} = ± 15 V		25		ns	
t _{d(off)}	I _{Cnom} = 8 A, T _i = 125 °C		370		ns	
t _f	$R_{Gon} = R_{Goff} = 82 \Omega$		85		ns	
Eon	inductive load		0,9		mJ	
E _{off}			0,9		mJ	
Diode - Ir	verter	·				
V _F = V _{EC}	I _{Fnom} = 8 A, T _i = 25 (125) °C		1,9 (2)	2,2 (2,4)	V	
V _(TO)	T _i = 25 (125) °C		1 (0,8)	1,1 (0,9)	V	
r _T	T _i = 25 (125) °C		112 (150)	138 (187)	mΩ	
R _{th(j-s)}	per diode		2,5		K/W	
I _{RRM}	under following conditions		13		Α	
Q _{rr}	I _{Enom} = 8 A, V _R = 600 V		1,6		μC	
E _{rr}	V _{GE} = 0 V, T _i = 125 °C		0,7		mJ	
	di _F /dt = 480 A/µs					
Temperature Sensor						
R _{ts}	%, T _r = () °C		()		Ω	
Mechanic	cal Data	1				
m			21,5		g	
Ms	Mounting torque	2		2,5	Nm	

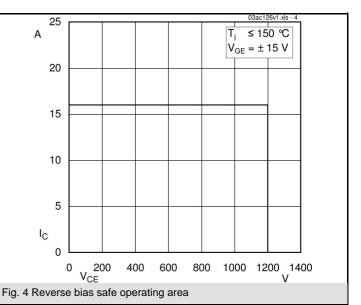


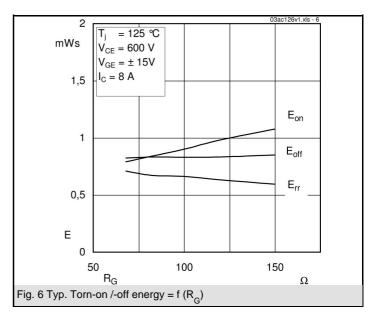


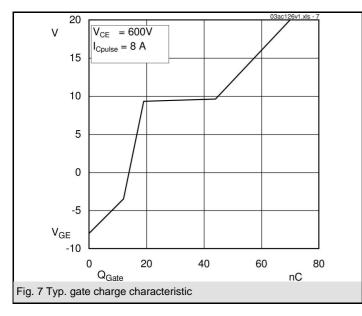


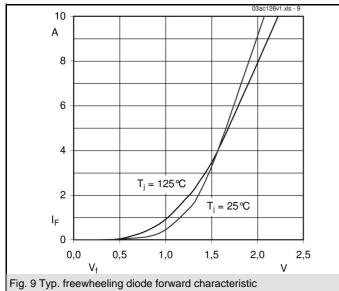


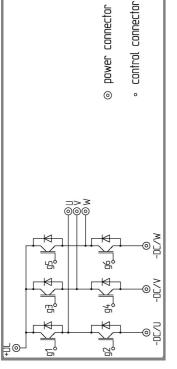


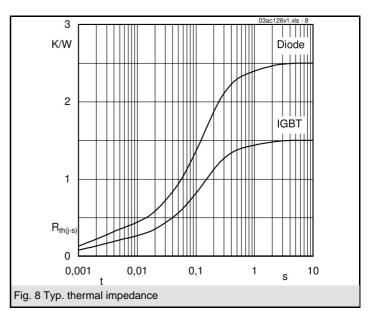








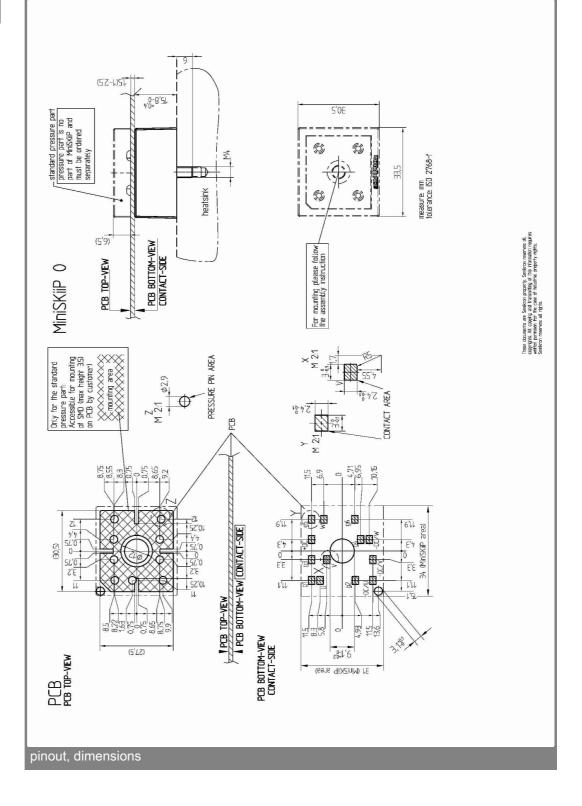




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circuit



This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

* The specifications of our components may not be considered as an assurance of component characteristics. Components have to be tested for the respective application. Adjustments may be necessary. The use of SEMIKRON products in life support appliances and systems is subject to prior specification and written approval by SEMIKRON. We therefore strongly recommend prior consultation of our personal.